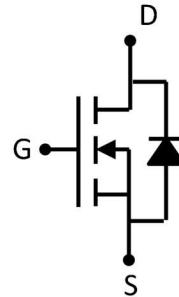


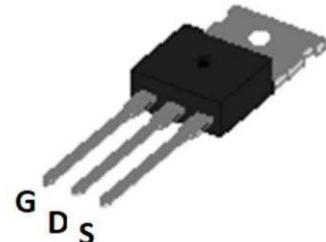
Feature

- 60V,184A
 $R_{DS\ (ON)} < 3.5\text{ m}\Omega$ @ $V_{GS}=10\text{ V}$ TYP:2.6 mΩ
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent $R_{DS\ (ON)}$ and Low Gate Charge



Application

- PWM applications
- Load Switch
- Power management



TO-220C

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
G035N06	APG035N06	TO-220C	-	-	1000

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_c = 25^\circ\text{C}$)	I_D	184	A
Continuous Drain Current ($T_c = 100^\circ\text{C}$)	I_D	116	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	736	A
Single Pulsed Avalanche Energy ⁽²⁾	E_{AS}	352	mJ
Power Dissipation	P_D	208	W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.6	°C/W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	42	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

APG035N06

N-Channel Enhancement Mosfet

MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

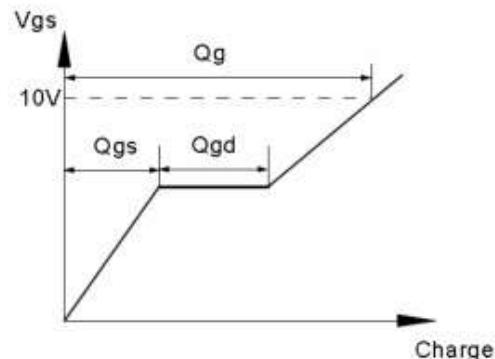
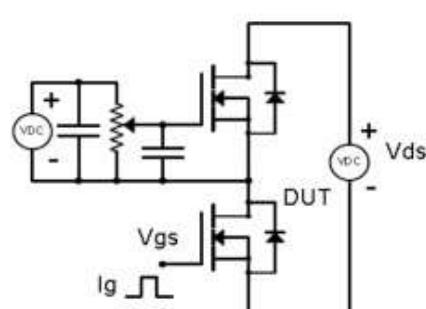
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	60	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
Gate threshold voltage ⁽³⁾	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	V
Drain-source on-resistance ⁽³⁾	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 40\text{A}$	-	2.6	3.5	$\text{m}\Omega$
Forward transconductance ⁽³⁾	g_{FS}	$V_{DS} = 5V, I_D = 40\text{A}$	-	89	-	S
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 30V, V_{GS} = 0V, f = 1\text{MHz}$	-	5425	-	pF
Output Capacitance	C_{oss}		-	1080	-	
Reverse Transfer Capacitance	C_{rss}		-	26	-	
Switching characteristics						
Turn-on delay time	$t_{d(\text{on})}$	$V_{DD} = 30V, I_D = 20\text{A}, R_L = 2\Omega$ $V_{GS} = 10V, R_G = 3\Omega$	-	26.5	-	ns
Turn-on rise time	t_r		-	15	-	
Turn-off delay time	$t_{d(\text{off})}$		-	72	-	
Turn-off fall time	t_f		-	18	-	
Total Gate Charge	Q_g	$V_{DS} = 30V, I_D = 20\text{A},$ $V_{GS} = 10V$	-	72	-	nC
Gate-Source Charge	Q_{gs}		-	20	-	
Gate-Drain Charge	Q_{gd}		-	14	-	
Reverse Recovery Charge	Q_{rr}	$I_F = 20\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	90	-	nC
Reverse Recovery Time	T_{rr}	$I_F = 20\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	25	-	ns
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V_{DS}	$V_{GS} = 0V, I_S = 20\text{A}$	-	-	1.2	V
Diode Forward current ⁽⁴⁾	I_S		-	-	184	A

Notes:

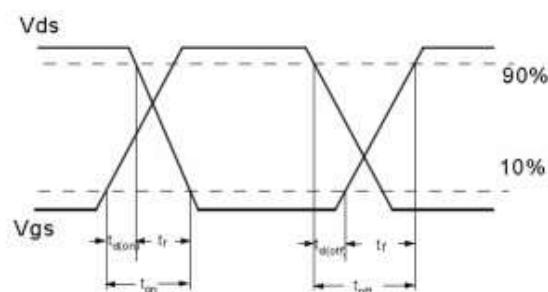
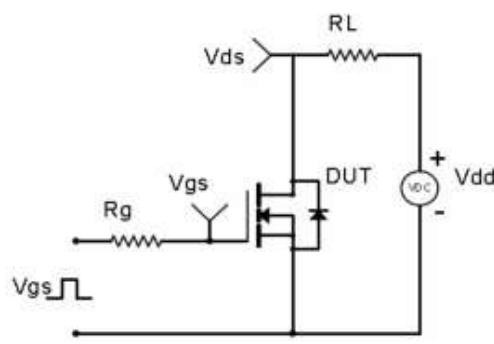
1. Repetitive Rating: pulse width limited by maximum junction temperature
2. EAS Condition: $T_J = 25^\circ\text{C}, V_{DD} = 50V, R_G = 25\Omega, L = 0.5\text{mH}$
3. Pulse Test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
4. Surface Mounted on FR4 Board, $t \leq 10$ sec

Test Circuit & Waveform

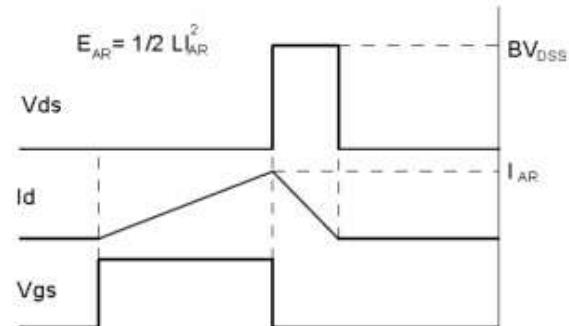
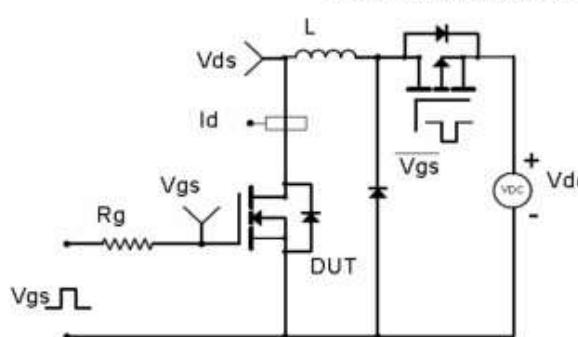
Gate Charge Test Circuit & Waveform



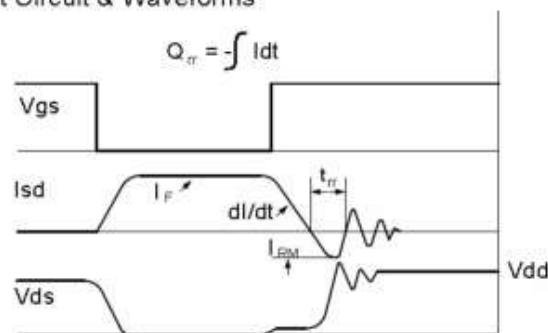
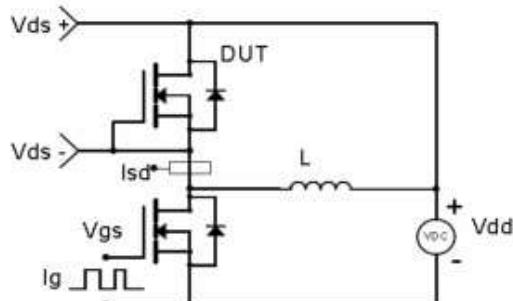
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Typical Characteristics

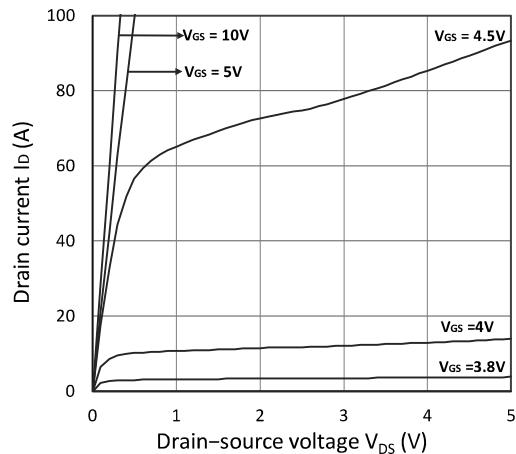


Figure 1. Output Characteristics

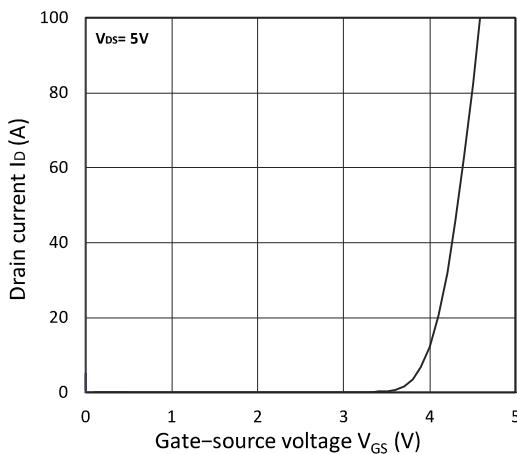


Figure 2. Transfer Characteristics

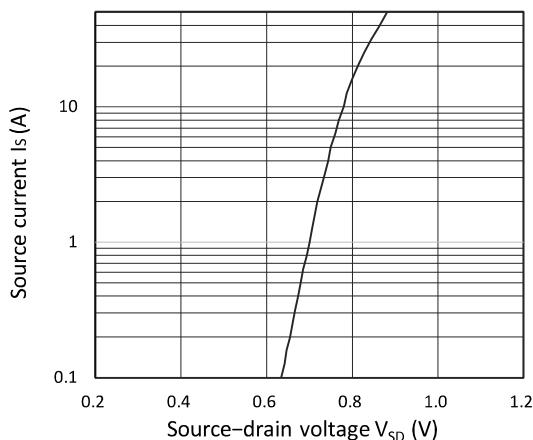


Figure 3. Forward Characteristics of Reverse

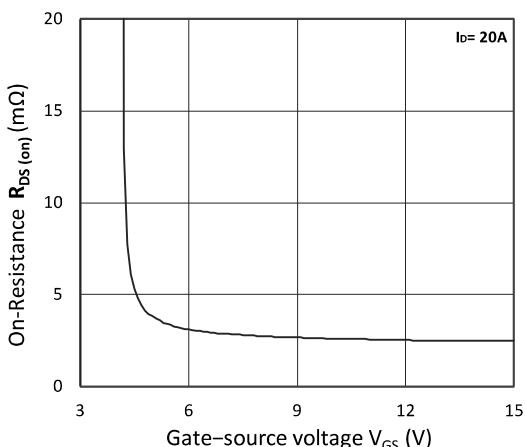


Figure 4. $R_{DS(on)}$ vs. V_{GS}

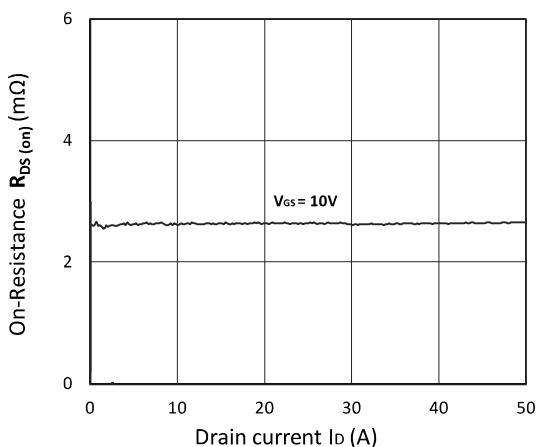


Figure 5. $R_{DS(on)}$ vs. I_D

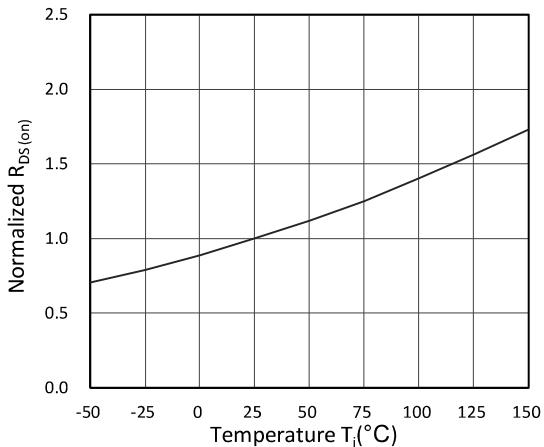


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

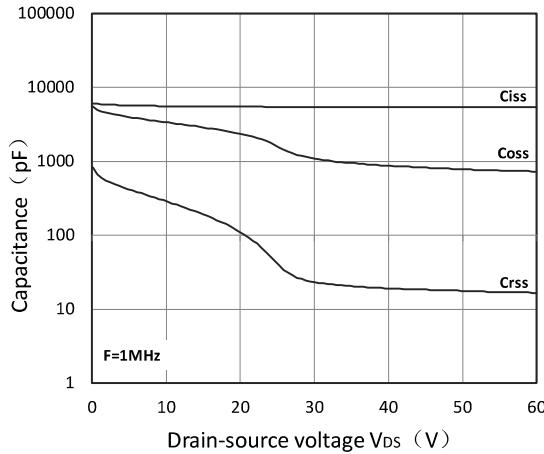


Figure 7. Capacitance Characteristics

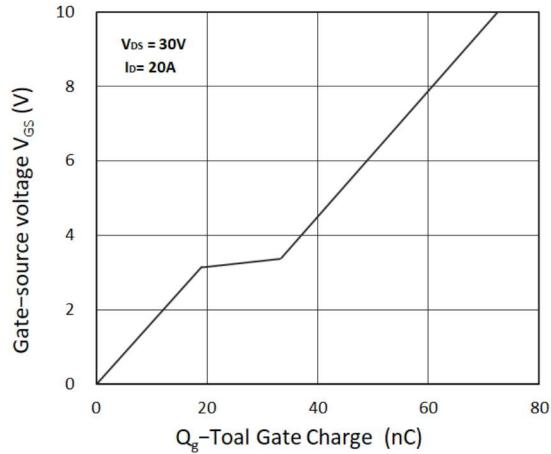


Figure 8. Gate Charge Characteristics

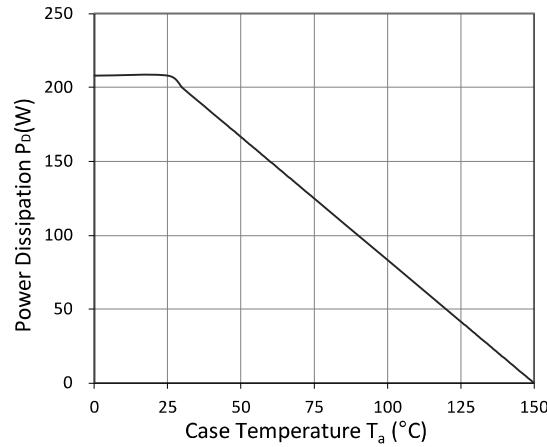


Figure 9. Power Dissipation

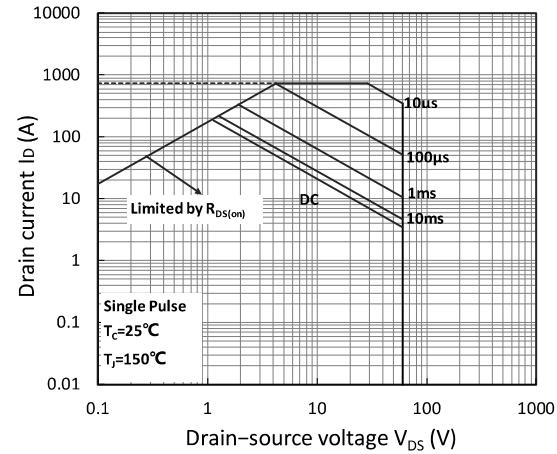


Figure10. Safe Operating Area

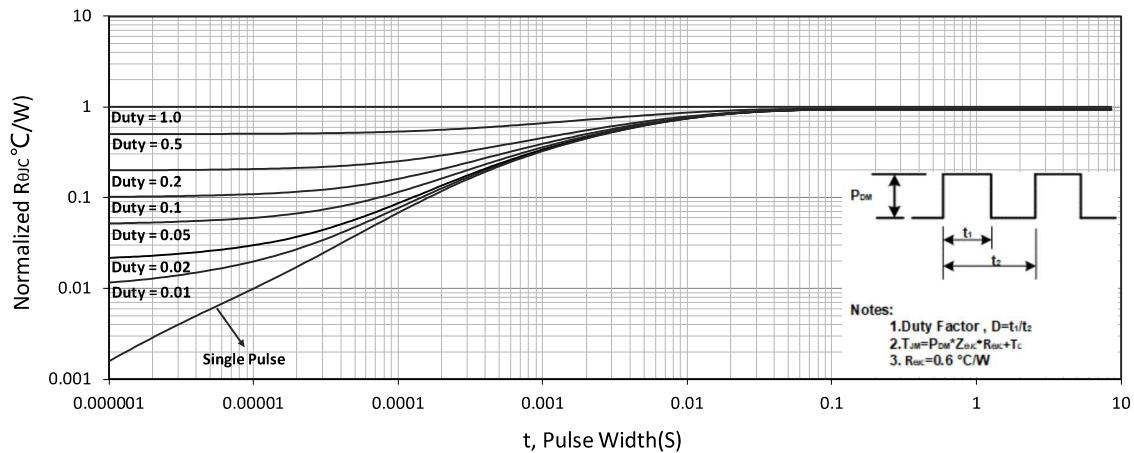
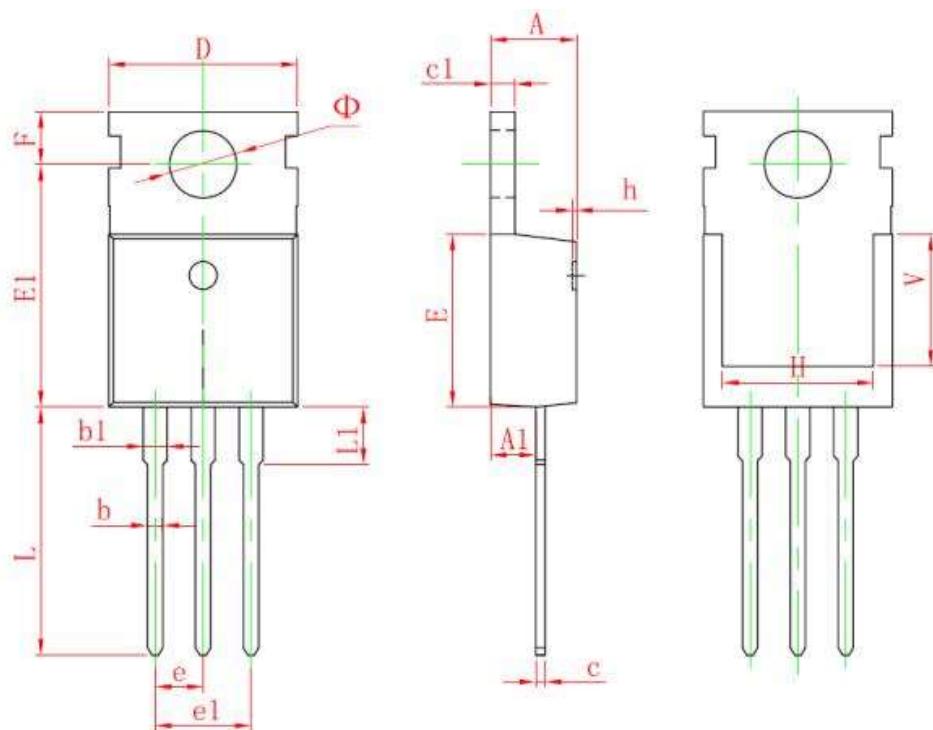


Figure 11. Normalized Maximum Transient Thermal Impedance

TO220C Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900 REF.		0.276 REF.	
Φ	3.400	3.800	0.134	0.150